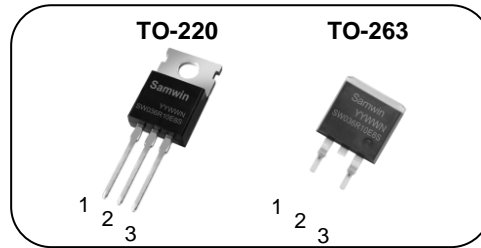


### N-channel Enhanced mode TO-220/TO-263 MOSFET

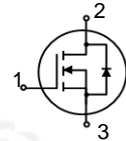
#### Features

- High ruggedness
- Low  $R_{DS(ON)}$  (Typ 3.8m $\Omega$ )@ $V_{GS}=10V$
- Low Gate Charge (Typ 85nC)
- Improved dv/dt Capability
- 100% Avalanche Tested
- Application: Synchronous Rectification, Li Battery Protect Board, Motor Drivers



1. Gate 2. Drain 3. Source

$BV_{DSS}$  : 100V  
 $I_D$  : 175A  
 $R_{DS(ON)}$  : 3.8m $\Omega$



#### General Description

This power MOSFET is produced with advanced technology of SAMWIN. This technology enable the power MOSFET to have better characteristics, including fast switching time, low on resistance, low gate charge and especially excellent avalanche characteristics.

#### Order Codes

Item	Sales Type	Marking	Package	Packaging
1	SW P 036R10E8S	SW036R10E8S	TO-220	TUBE
2	SW B 036R10E8S	SW036R10E8S	TO-263	TUBE

#### Absolute maximum ratings

Symbol	Parameter	Value		Unit
		TO-220	TO-263	
$V_{DSS}$	Drain to source voltage	100		V
$I_D$	Continuous drain current (@ $T_C=25^\circ C$ , Silicon Limited)	175*		A
	Continuous drain current (@ $T_C=100^\circ C$ , Silicon Limited)	132*		A
	Continuous drain current (@ $T_C=25^\circ C$ , Package Limited)	135		A
$I_{DM}$	Drain current pulsed (note 1)	700		A
$V_{GS}$	Gate to source voltage	$\pm 20$		V
$E_{AS}$	Single pulsed avalanche energy (note 2)	812		mJ
$E_{AR}$	Repetitive avalanche energy (note 1)	80		mJ
dv/dt	Peak diode recovery dv/dt (note 3)	5		V/ns
$P_D$	Total power dissipation (@ $T_C=25^\circ C$ )	312.5		W
	Derating factor above 25 $^\circ C$	2.5		W/ $^\circ C$
$T_{STG}, T_J$	Operating junction temperature & storage temperature	-55 ~ + 150		$^\circ C$
$T_L$	Maximum lead temperature for soldering purpose, 1/8 from case for 5 seconds.	300		$^\circ C$

\*. Drain current is limited by junction temperature. Package limitation current is 135A.

#### Thermal characteristics

Symbol	Parameter	Value		Unit
		TO-220	TO-263	
$R_{thjc}$	Thermal resistance, Junction to case	0.4		$^\circ C/W$
$R_{thja}$	Thermal resistance, Junction to ambient	53		$^\circ C/W$

## Electrical characteristic ( $T_J = 25^\circ\text{C}$ unless otherwise specified )

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
<b>Off characteristics</b>						
$BV_{DSS}$	Drain to source breakdown voltage	$V_{GS}=0V, I_D=250\mu A$	100			V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown voltage temperature coefficient	$I_D=250\mu A$ , referenced to $25^\circ\text{C}$		0.05		V/ $^\circ\text{C}$
$I_{DSS}$	Drain to source leakage current	$V_{DS}=100V, V_{GS}=0V$			1	$\mu A$
		$V_{DS}=80V, T_J=125^\circ\text{C}$			50	$\mu A$
$I_{GSS}$	Gate to source leakage current, forward	$V_{GS}=20V, V_{DS}=0V$			100	nA
	Gate to source leakage current, reverse	$V_{GS}=-20V, V_{DS}=0V$			-100	nA
<b>On characteristics</b>						
$V_{GS(TH)}$	Gate threshold voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2		4	V
$R_{DS(ON)}$	Drain to source on state resistance	$V_{GS}=10V, I_D=20A, T_J=25^\circ\text{C}$		3.8	4.6	m $\Omega$
		$V_{GS}=10V, I_D=20A, T_J=125^\circ\text{C}$		6.2		m $\Omega$
$G_{fs}$	Forward transconductance	$V_{DS}=5V, I_D=30A$		76		S
<b>Dynamic characteristics</b>						
$C_{iss}$	Input capacitance	$V_{GS}=0V, V_{DS}=50V, f=100\text{kHz}$		6263		pF
$C_{oss}$	Output capacitance			939		
$C_{rss}$	Reverse transfer capacitance			19		
$t_{d(on)}$	Turn on delay time	$V_{DS}=50V, I_D=30A, R_G=4.7\Omega, V_{GS}=10V$ (note 4,5)		33		ns
$t_r$	Rising time			35		
$t_{d(off)}$	Turn off delay time			59		
$t_f$	Fall time			14		
$Q_g$	Total gate charge	$V_{DS}=80V, V_{GS}=10V, I_D=30A, I_G=5\text{mA}$ (note 4,5)		85		nC
$Q_{gs}$	Gate-source charge			31		
$Q_{gd}$	Gate-drain charge			13		
$R_g$	Gate resistance	$V_{DS}=0V$ , Scan F mode		3		$\Omega$

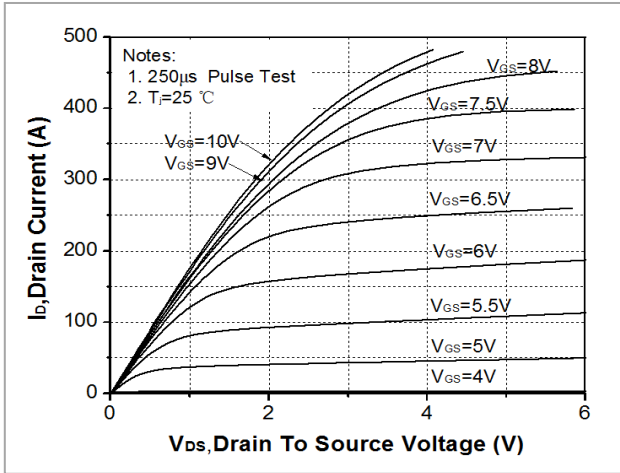
## Source to drain diode ratings characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous source current	Integral reverse p-n Junction diode in the MOSFET			175	A
$I_{SM}$	Pulsed source current				700	A
$V_{SD}$	Diode forward voltage drop.	$I_S=50A, V_{GS}=0V$			1.4	V
$t_{rr}$	Reverse recovery time	$I_S=30A, V_{GS}=0V,$		68		ns
$Q_{rr}$	Reverse recovery charge	$di/dt=100A/\mu s$		142		nC

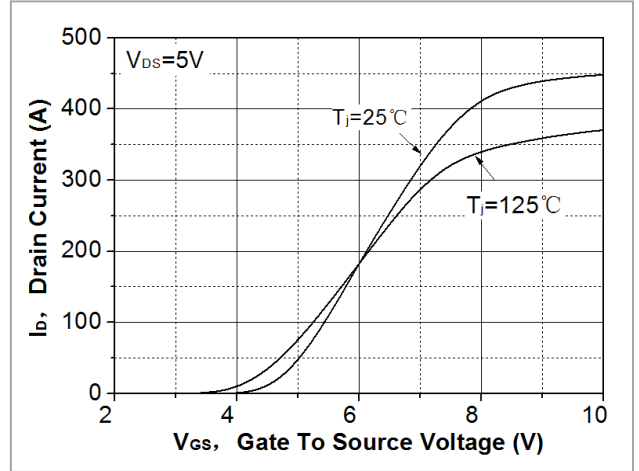
### ※. Notes

1. Repeattive rating : pulse width limited by junction temperature.
2.  $L=0.5\text{mH}, I_{AS}=57A, V_{DD}=50V, R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$
3.  $I_{SD} \leq 30A, di/dt = 100A/\mu s, V_{DD} \leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$
4. Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
5. Essentially independent of operating temperature.

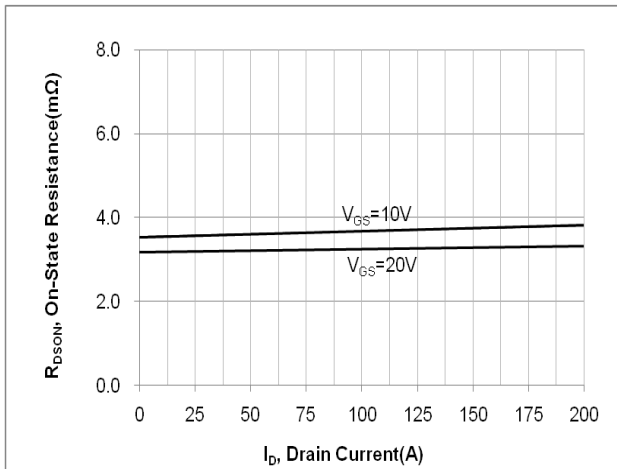
**Fig. 1. On-state characteristics**



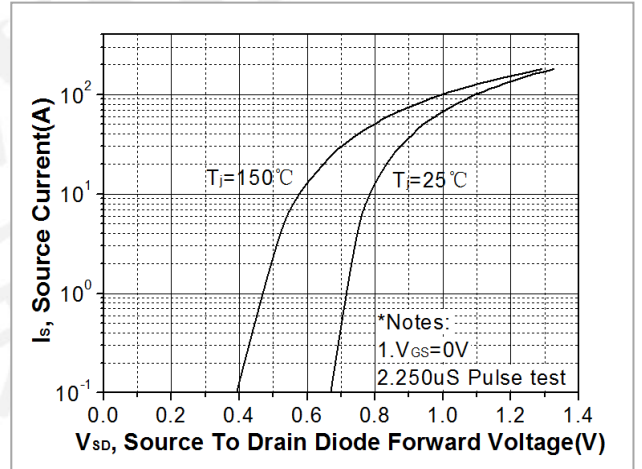
**Fig. 2. Transfer Characteristics**



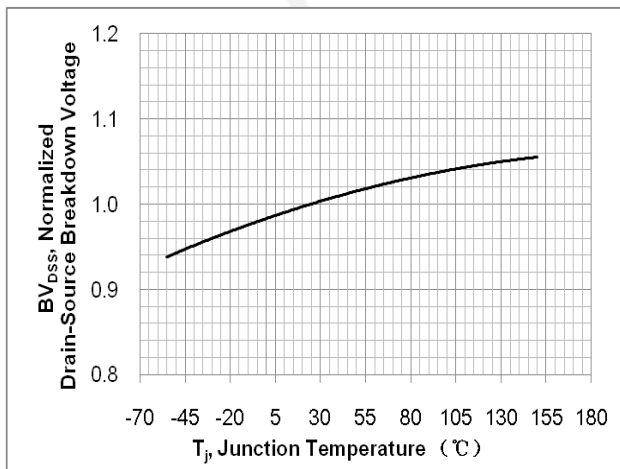
**Fig. 3. On-resistance variation vs. drain current and gate voltage**



**Fig. 4. On-state current vs. diode forward voltage**



**Fig 5. Breakdown voltage variation vs. junction temperature**



**Fig. 6. On-resistance variation vs. junction temperature**

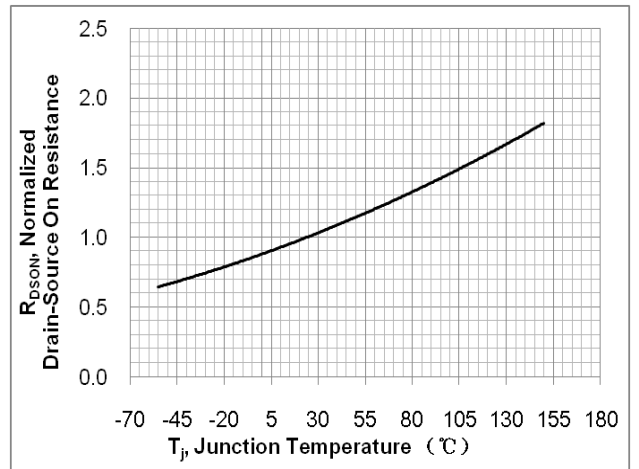


Fig. 7. Gate charge characteristics

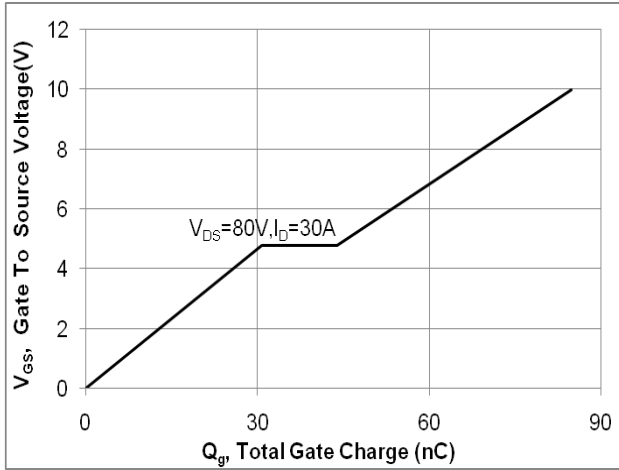


Fig. 8. Capacitance Characteristics

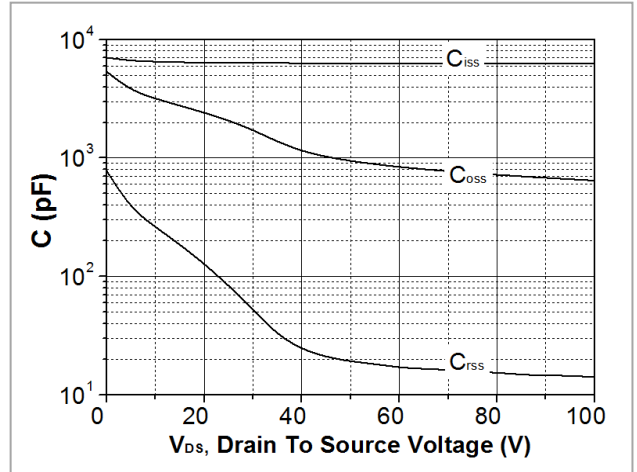


Fig. 9. Maximum safe operating area (TO-220/TO-263)

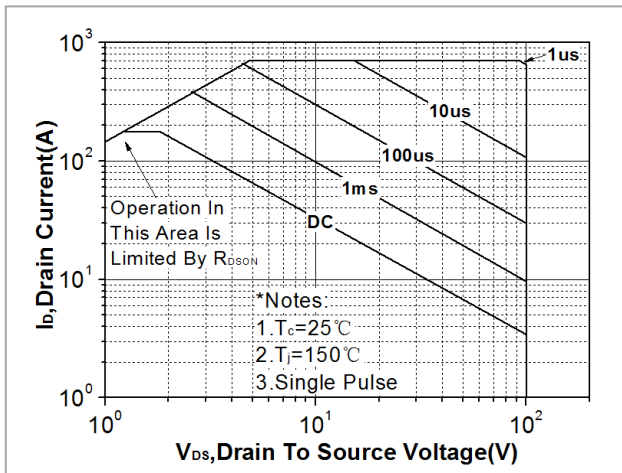


Fig. 10. Maximum drain current vs. case temperature (TO-220/TO-263)

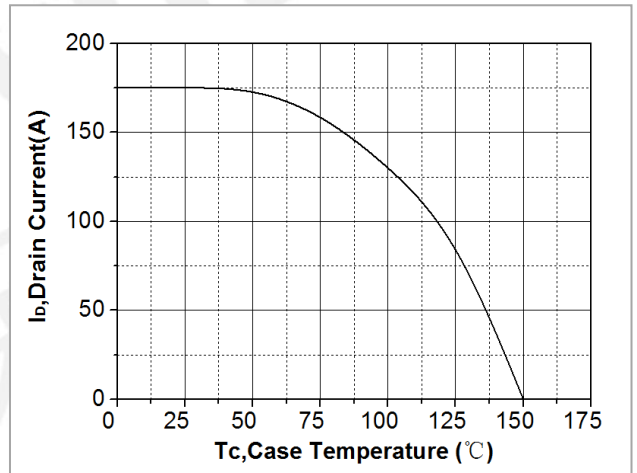


Fig. 11. Transient thermal response curve (TO-220/TO-263)

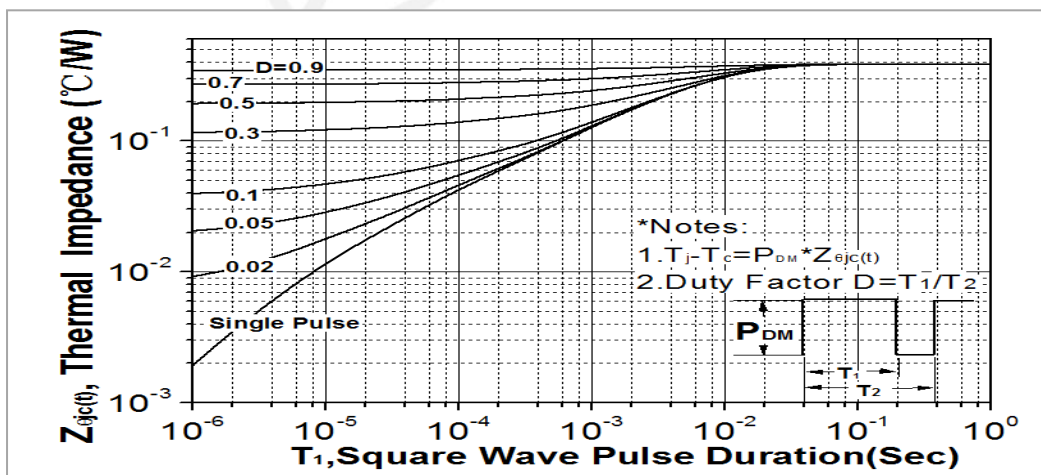


Fig. 12. Gate charge test circuit & waveform

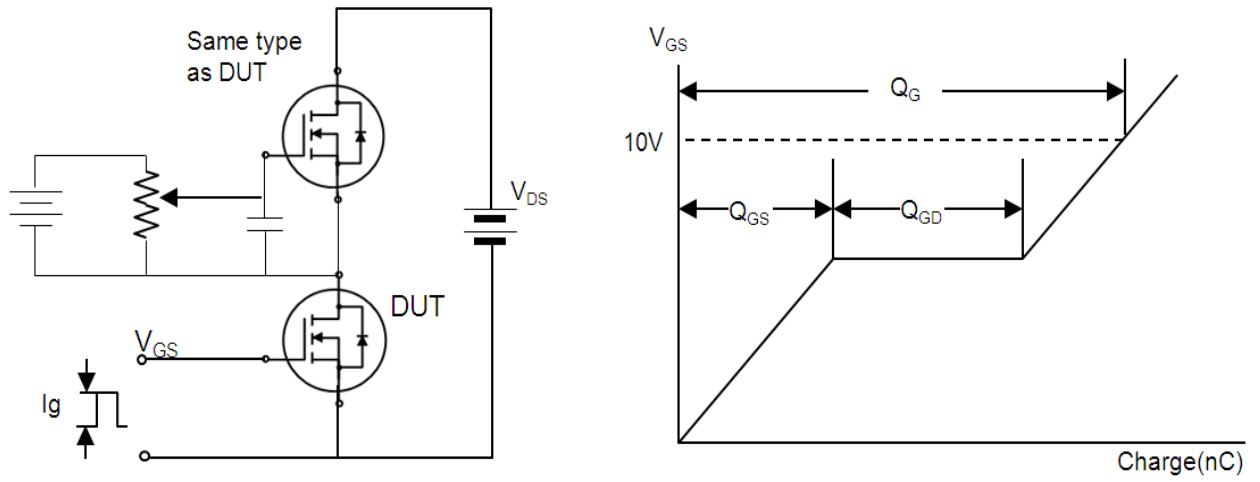


Fig. 13. Switching time test circuit & waveform

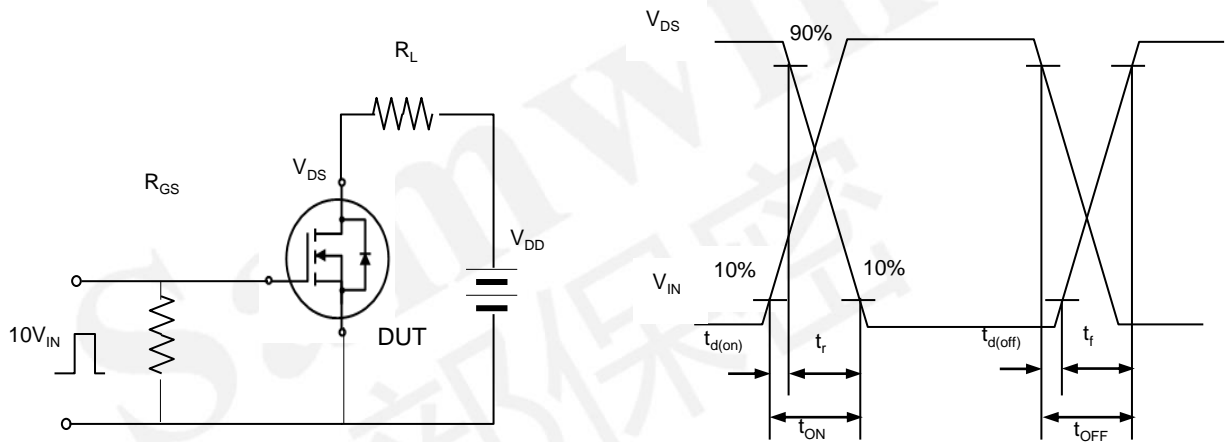


Fig. 14. Unclamped Inductive switching test circuit & waveform





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